

Analog Multiplexers/ Demultiplexers with Injection Current Effect Control

Automotive Customized

These devices are pin compatible to standard HC405x and MC1405xB analog mux/demux devices, but feature injection current effect control. This makes them especially suited for usage in automotive applications where voltages in excess of normal logic voltage are common.

The injection current effect control allows signals at disabled analog input channels to exceed the supply voltage range without affecting the signal of the enabled analog channel. This eliminates the need for external diode/resistor networks typically used to keep the analog channel signals within the supply voltage range.

The devices utilize low power silicon gate CMOS technology. The Channel Select and Enable inputs are compatible with standard CMOS outputs.

- Injection Current Cross-Coupling Less than 1mV/mA (See Figure 9)
- Pin Compatible to HC405X and MC1405XB Devices
- Power Supply Range ($V_{CC} - GND$) = 2.0 to 6.0 V
- In Compliance With the Requirements of JEDEC Standard No. 7A
- Chip Complexity: 154 FETs or 36 Equivalent Gates

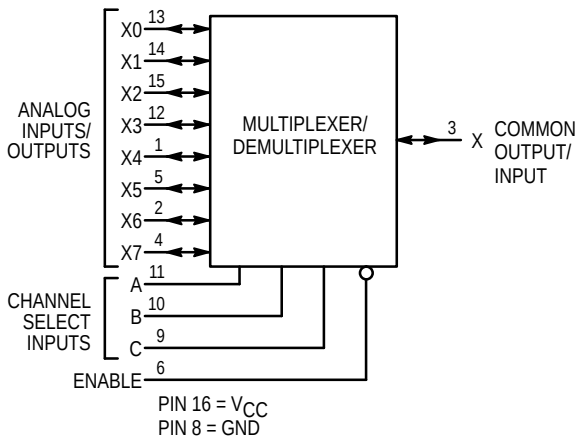


Figure 1. MC74HC4851A Logic Diagram
Single-Pole, 8-Position Plus Common Off

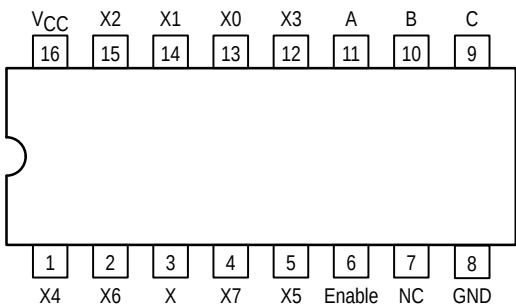
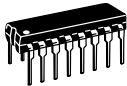


Figure 2. MC74HC4851A 16-Lead Pinout (Top View)

MC74HC4851A MC74HC4852A



N SUFFIX
16-LEAD PLASTIC DIP PACKAGE
CASE 648-08



D SUFFIX
16-LEAD PLASTIC SOIC PACKAGE
CASE 751B-05



DW SUFFIX
16-LEAD PLASTIC WIDE SOIC PACKAGE
CASE 751G-02



DT SUFFIX
16-LEAD PLASTIC TSSOP PACKAGE
CASE 948F-01

ORDERING INFORMATION

MC74HCXXXAN	Plastic
MC74HCXXXAD	SOIC
MC74HCXXXADW	SOIC Wide
MC74HCXXXADT	TSSOP

FUNCTION TABLE – MC74HC4851A

Control Inputs				ON Channels
Enable	Select			
	C	B	A	
L	L	L	L	X0
L	L	L	H	X1
L	L	H	L	X2
L	L	H	H	X3
L	H	L	L	X4
L	H	L	H	X5
L	H	H	L	X6
L	H	H	H	X7
H	X	X	X	NONE



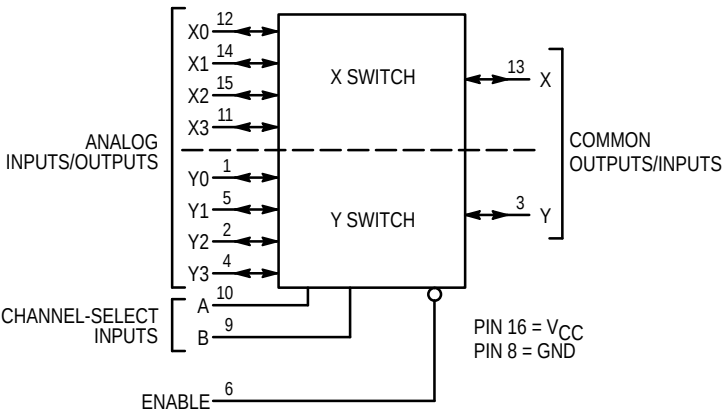


Figure 3. MC74HC4852A Logic Diagram
Double-Pole, 4-Position Plus Common Off

FUNCTION TABLE – MC74HC4852A				
Control Inputs				
Enable	Select			
	B	A	ON Channels	
L	L	L	Y0	X0
L	L	H	Y1	X1
L	H	L	Y2	X2
L	H	H	Y3	X3
H	X	X	NONE	

X = Don't Care

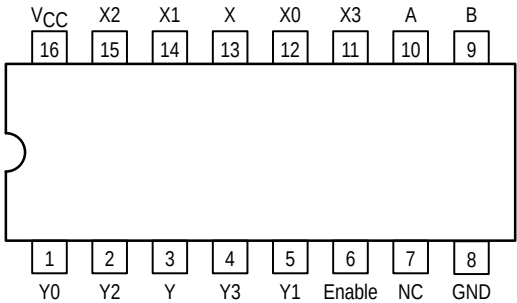


Figure 4. MC74HC4852A 16-Lead Pinout (Top View)

MAXIMUM RATINGS*

Symbol	Parameter	Value	Unit
V_{CC}	Positive DC Supply Voltage (Referenced to GND)	– 0.5 to + 7.0	V
V_{in}	DC Input Voltage (Any Pin) (Referenced to GND)	– 0.5 to $V_{CC} + 0.5$	V
I	DC Current, Into or Out of Any Pin	± 25	mA
P_D	Power Dissipation in Still Air, Plastic DIP† SOIC Package† TSSOP Package†	750 500 450	mW
T_{stg}	Storage Temperature Range	– 65 to + 150	°C
T_L	Lead Temperature, 1 mm from Case for 10 Seconds Plastic DIP, SOIC or TSSOP Package	260	°C

* Maximum Ratings are those values beyond which damage to the device may occur. Functional operation should be restricted to the Recommended Operating Conditions.

† Derating — Plastic DIP: – 10 mW/°C from 65° to 125°C

SOIC Package: – 7 mW/°C from 65° to 125°C

TSSOP Package: – 6.1 mW/°C from 65° to 125°C

For high frequency or heavy load considerations, see Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range $GND \leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit	
V _{CC}	Positive DC Supply Voltage (Referenced to GND)	2.0	6.0	V	
V _{in}	DC Input Voltage (Any Pin) (Referenced to GND)	GND	V _{CC}	V	
V _{IO} *	Static or Dynamic Voltage Across Switch	0.0	1.2	V	
T _A	Operating Temperature Range, All Package Types	− 55	+ 125	°C	
t _r , t _f	Input Rise/Fall Time (Channel Select or Enable Inputs)	V _{CC} = 2.0 V V _{CC} = 4.5 V V _{CC} = 6.0 V	0 0 0	1000 500 400	ns

* For voltage drops across switch greater than 1.2V (switch on), excessive V_{CC} current may be drawn; i.e., the current out of the switch may contain both V_{CC} and switch input components. The reliability of the device will be unaffected unless the Maximum Ratings are exceeded.

DC CHARACTERISTICS — Digital Section (Voltages Referenced to GND) $V_{EE} = \text{GND}$, Except Where Noted

Symbol	Parameter	Condition	V_{CC} V	Guaranteed Limit			Unit
				–55 to 25°C	≤85°C	≤125°C	
V_{IH}	Minimum High-Level Input Voltage, Channel-Select or Enable Inputs	$R_{on} = \text{Per Spec}$	2.0 3.0 4.5 6.0	1.50 2.10 3.15 4.20	1.50 2.10 3.15 4.20	1.50 2.10 3.15 4.20	V
V_{IL}	Maximum Low-Level Input Voltage, Channel-Select or Enable Inputs	$R_{on} = \text{Per Spec}$	2.0 3.0 4.5 6.0	0.50 0.90 1.35 1.80	0.50 0.90 1.35 1.80	0.50 0.90 1.35 1.80	V
I_{in}	Maximum Input Leakage Current on Digital Pins (Enable/A/B/C)	$V_{in} = V_{CC} \text{ or GND}$	6.0	± 0.1	± 1.0	± 1.0	μA
I_{CC}	Maximum Quiescent Supply Current (per Package)	$V_{in}(\text{digital}) = V_{CC} \text{ or GND}$ $V_{in}(\text{analog}) = \text{GND}$	6.0	2	20	40	μA

NOTE: Information on typical parametric values can be found in Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

DC CHARACTERISTICS — Analog Section

Symbol	Parameter	Condition	V _{CC}	Guaranteed Limit			Unit
				–55 to 25°C	≤85°C	≤125°C	
R _{on}	Maximum “ON” Resistance	V _{in} = V _{IL} or V _{IH} ; V _{IS} = V _{CC} to GND; I _S ≤ 2.0 mA	2.0 3.0 4.5 6.0	1700 1100 550 400	1750 1200 650 500	1800 1300 750 600	Ω
ΔR _{on}	Delta “ON” Resistance	V _{in} = V _{IL} or V _{IH} ; V _{IS} = V _{CC} /2 I _S ≤ 2.0 mA	2.0 3.0 4.5 6.0	300 160 80 60	400 200 100 80	500 240 120 100	Ω
I _{off}	Maximum Off–Channel Leakage Current, Any One Channel Common Channel	V _{in} = V _{CC} or GND	6.0	±0.1 ±0.2	±0.5 ±2.0	±1.0 ±4.0	μA
I _{on}	Maximum On–Channel Leakage Channel–to–Channel	V _{in} = V _{CC} or GND	6.0	±0.2	±2.0	±4.0	μA

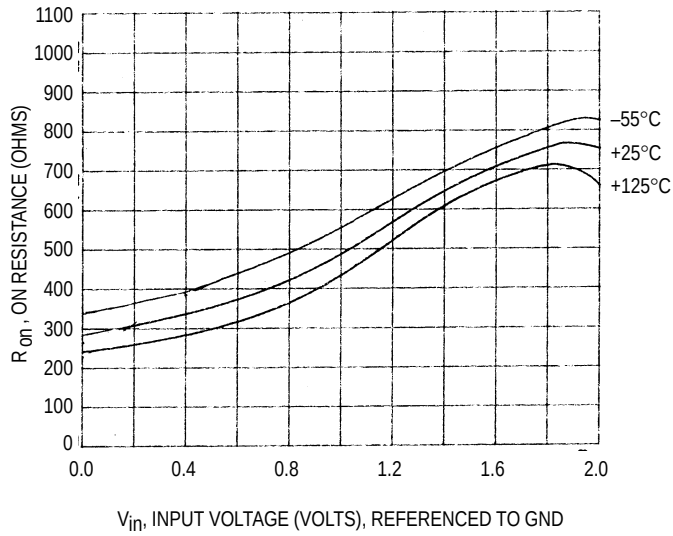
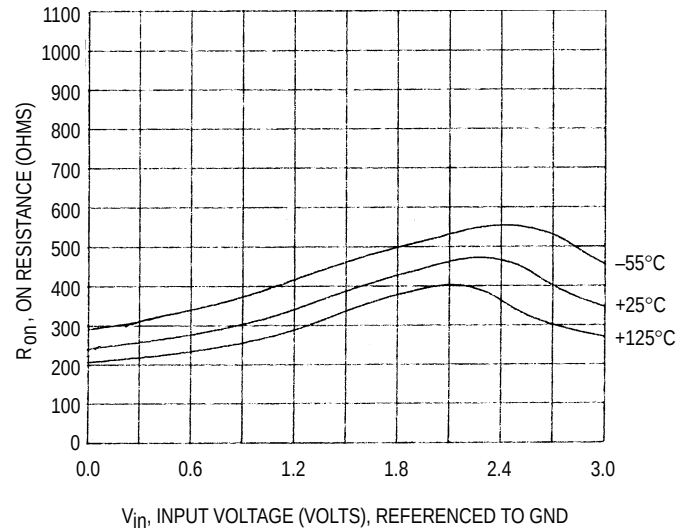
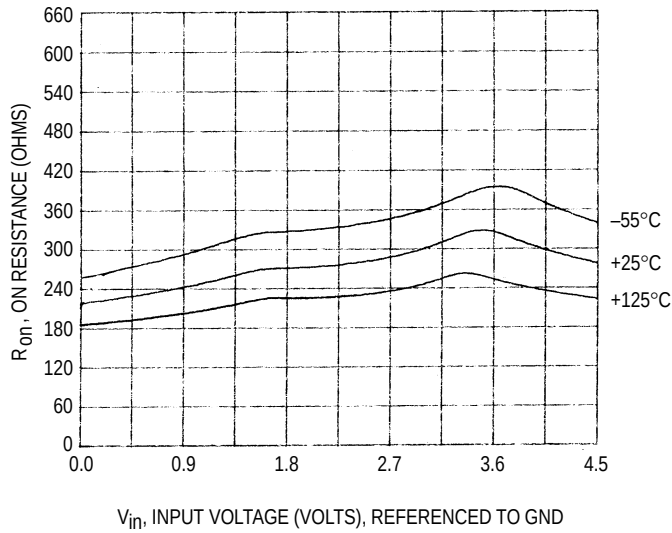
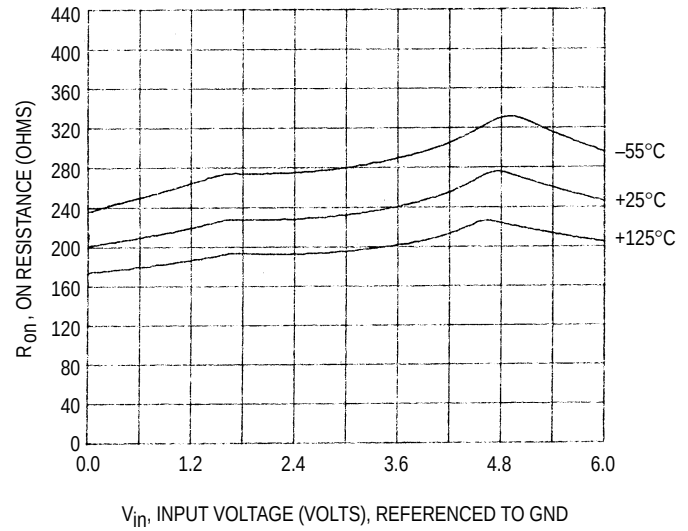
AC CHARACTERISTICS (C_L = 50 pF, Input t_r = t_f = 6 ns)

Symbol	Parameter	V _{CC}	–55 to 25°C	≤85°C	≤125°C	Unit
t _{PHL} , t _{PLH}	Maximum Propagation Delay, Analog Input to Analog Output	2.0 3.0 4.5 6.0	160 80 40 30	180 90 45 35	200 100 50 40	ns
t _{PHL} , t _{PHZ} , PZH t _{PLH} , t _{PLZ} , PZL	Maximum Propagation Delay, Enable or Channel–Select to Analog Output	2.0 3.0 4.5 6.0	260 160 80 60	280 180 90 70	300 200 100 80	ns
C _{in}	Maximum Input Capacitance (All Switches Off) (All Switches Off)	Digital Pins Any Single Analog Pin Common Analog Pin	10 35 130	10 35 130	10 35 130	pF
C _{PD}	Power Dissipation Capacitance	Typical	5.0	20		pF

INJECTION CURRENT COUPLING SPECIFICATIONS (V_{CC} = 5V, T_A = –55°C to +125°C)

Symbol	Parameter	Typ	Max	Unit	Condition
V _{Δout}	Maximum Shift of Output Voltage of Enabled Analog Channel	0.1 1.0 0.5 5.0	0.5 5.0 2.0 20	mV	I _{in} * ≤ 1mA, R _S ≤ 3,9kΩ I _{in} * ≤ 10mA, R _S ≤ 3,9kΩ I _{in} * ≤ 1mA, R _S ≤ 20kΩ I _{in} * ≤ 10mA, R _S ≤ 20kΩ

* I_{in} = Total current injected into all disabled channels.

Figure 5. Typical On Resistance $V_{CC} = 2V$ Figure 6. Typical On Resistance $V_{CC} = 3V$ Figure 7. Typical On Resistance $V_{CC} = 4.5V$ Figure 8. Typical On Resistance $V_{CC} = 6V$

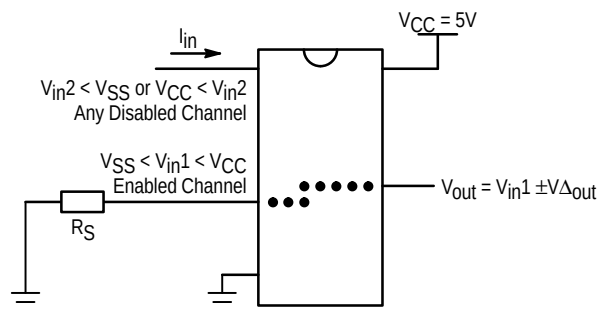


Figure 9. Injection Current Coupling Specification

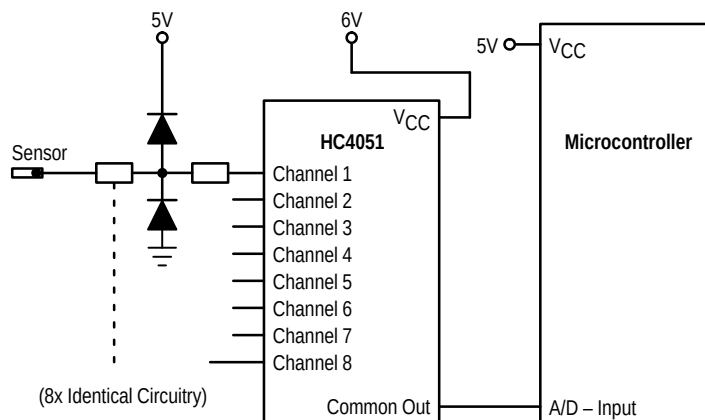


Figure 10. Actual Technology

Requires 32 passive components and one extra 6V regulator to suppress injection current into a standard HC4051 multiplexer

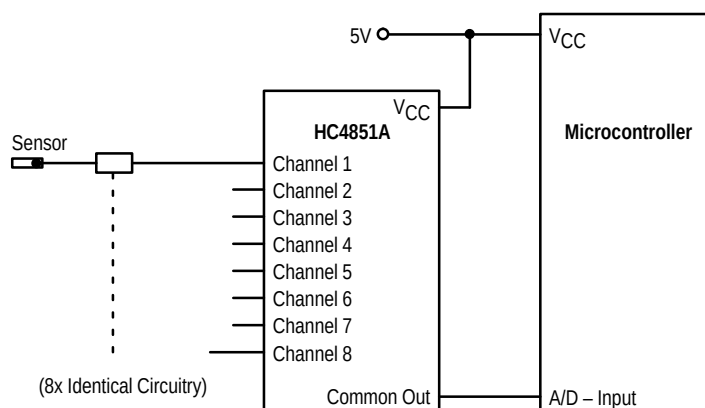


Figure 11. MC74HC4851A Solution

Solution by applying the HC4851A multiplexer

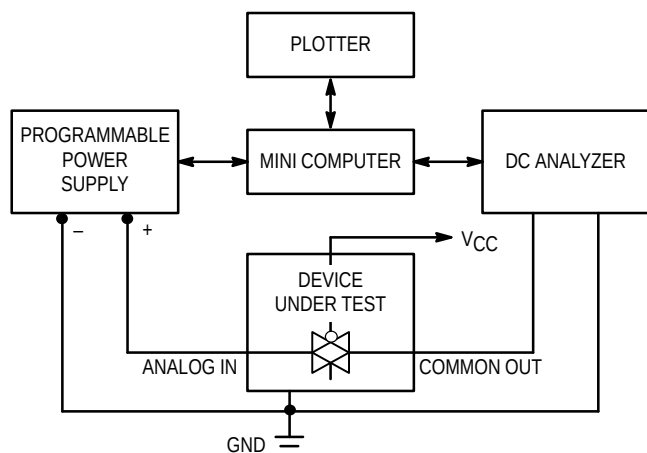
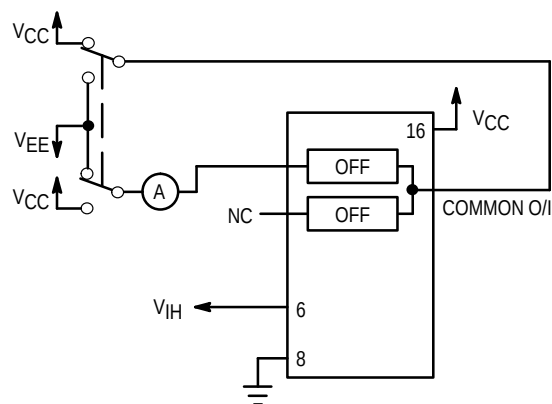


Figure 12. On Resistance Test Set-Up



**Figure 13. Maximum Off Channel Leakage Current,
Any One Channel, Test Set-Up**

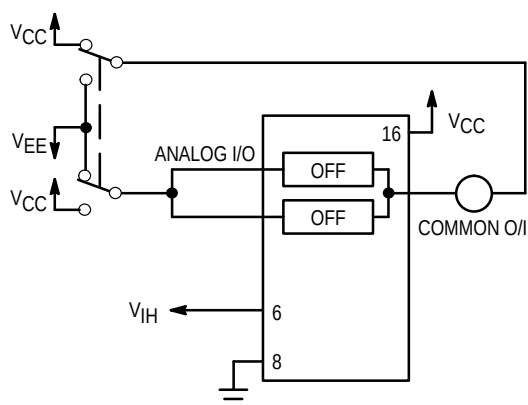


Figure 14. Maximum Off Channel Leakage Current, Common Channel, Test Set-Up

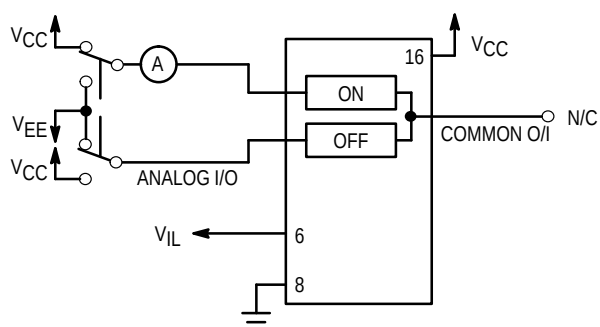


Figure 15. Maximum On Channel Leakage Current, Channel to Channel, Test Set-Up

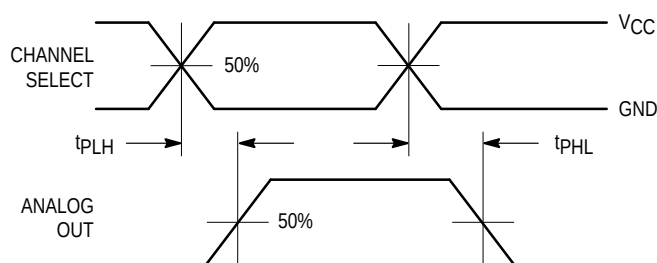
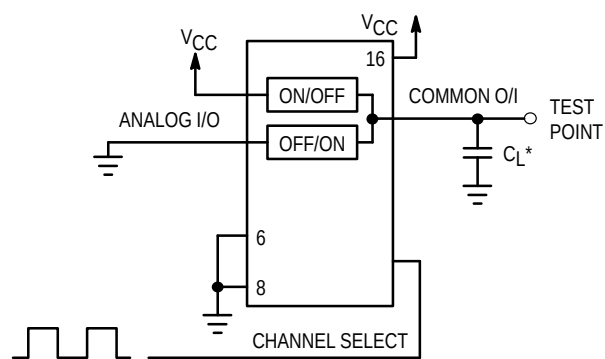


Figure 16. Propagation Delays, Channel Select to Analog Out



*Includes all probe and jig capacitance

Figure 17. Propagation Delay, Test Set-Up Channel Select to Analog Out

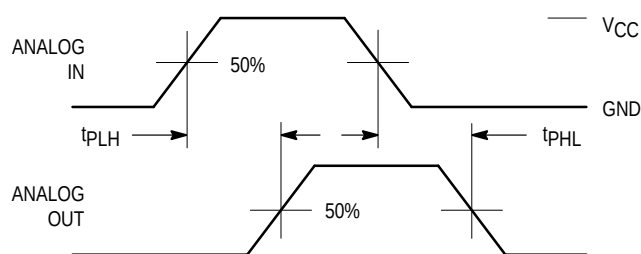
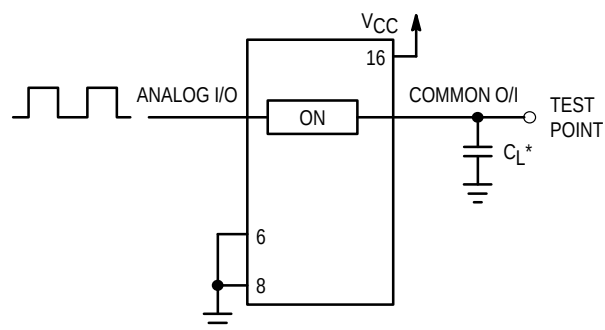


Figure 18. Propagation Delays, Analog In to Analog Out



*Includes all probe and jig capacitance

Figure 19. Propagation Delay, Test Set-Up Analog In to Analog Out

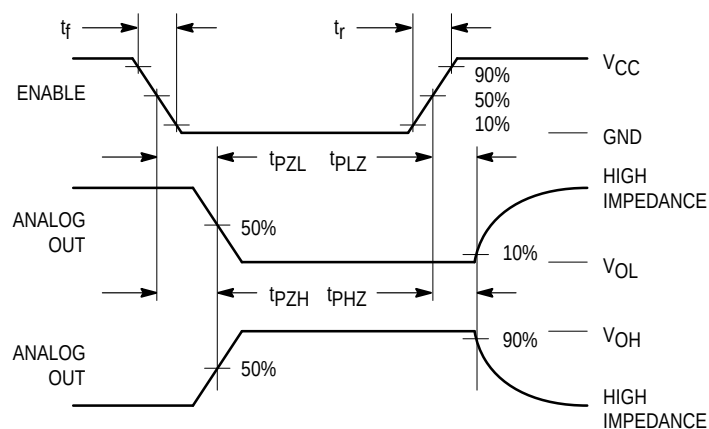


Figure 20. Propagation Delays, Enable to Analog Out

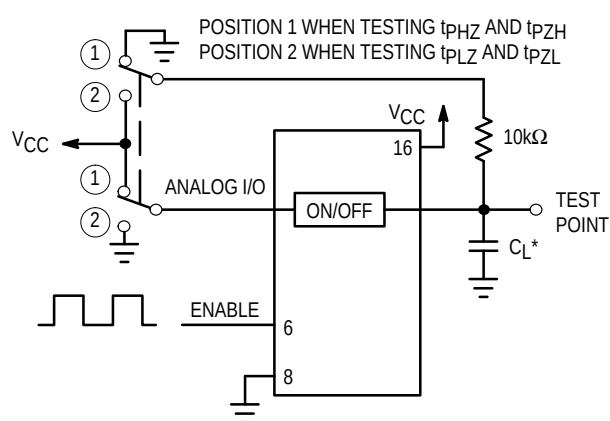


Figure 21. Propagation Delay, Test Set-Up Enable to Analog Out

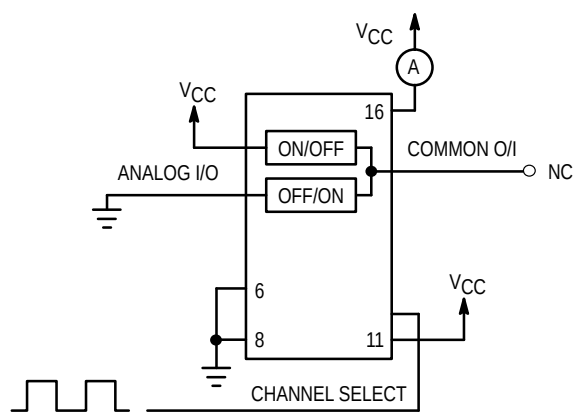


Figure 22. Power Dissipation Capacitance, Test Set-Up

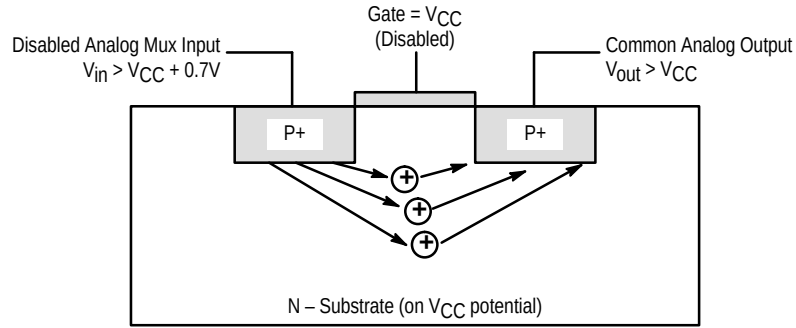


Figure 23. Diagram of Bipolar Coupling Mechanism
Appears if V_{in} exceeds V_{CC} , driving injection current into the substrate

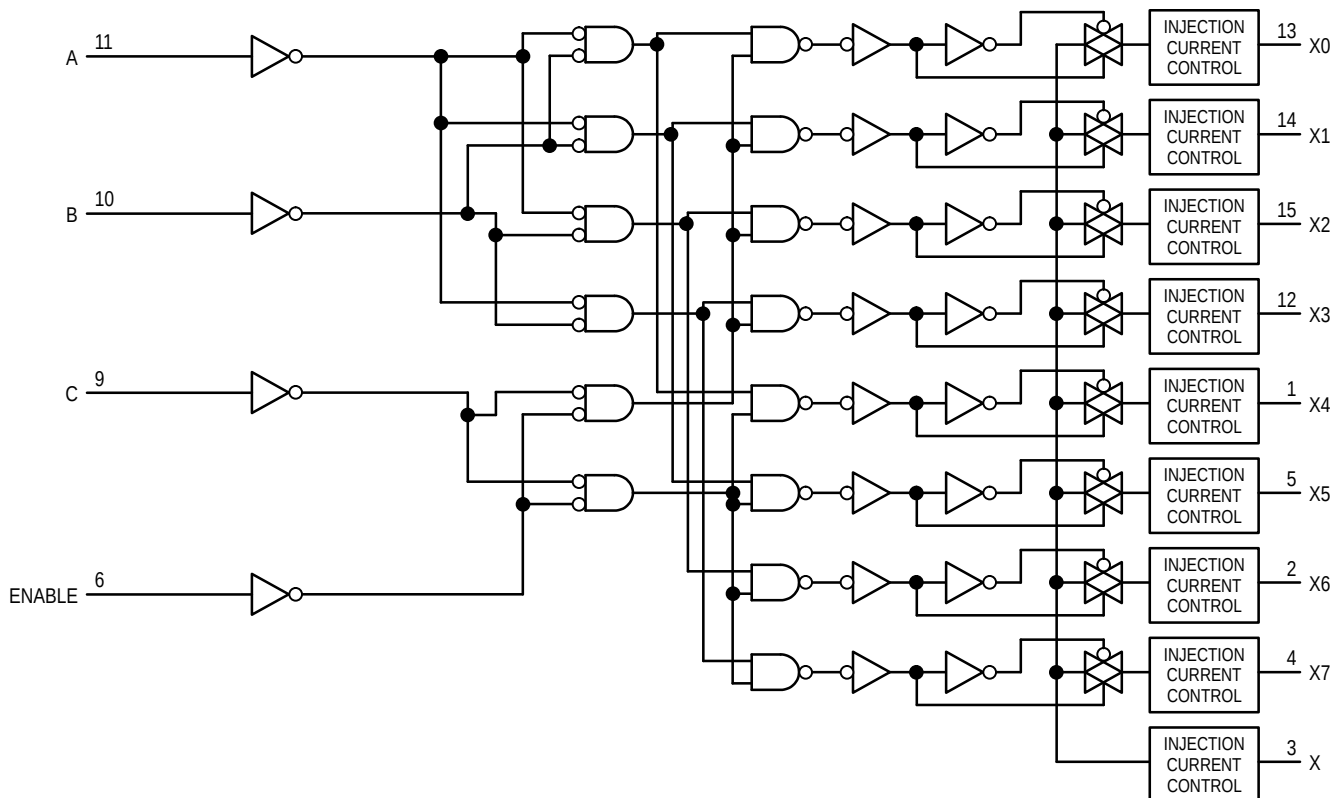


Figure 24. Function Diagram, HC4851A

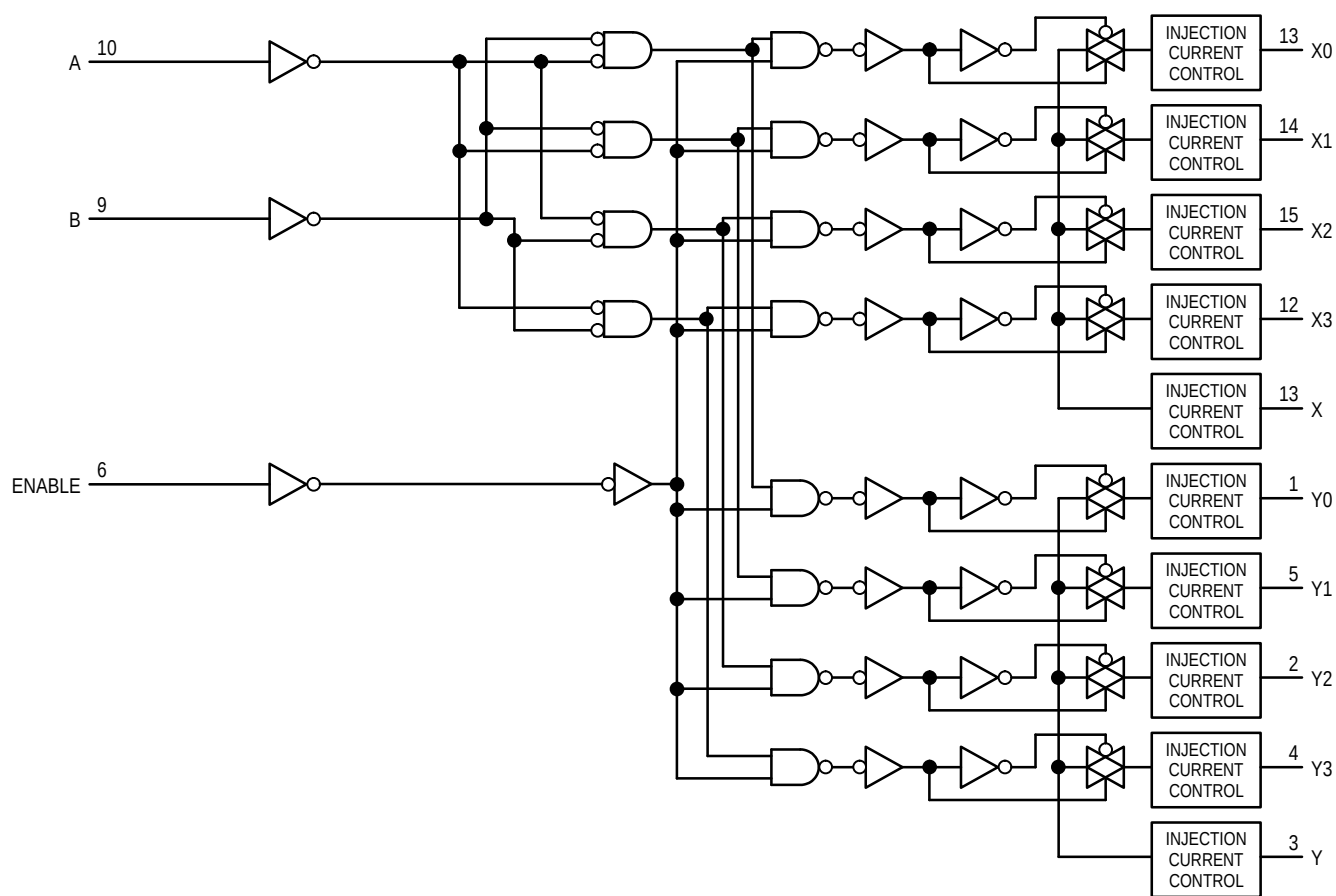
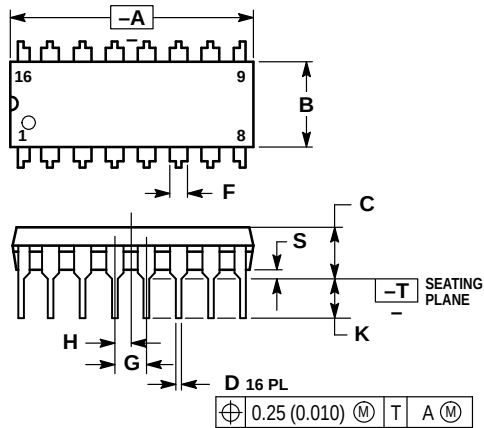


Figure 25. Function Diagram, HC4852A

OUTLINE DIMENSIONS

N SUFFIX
PLASTIC PACKAGE
CASE 648-08
ISSUE R

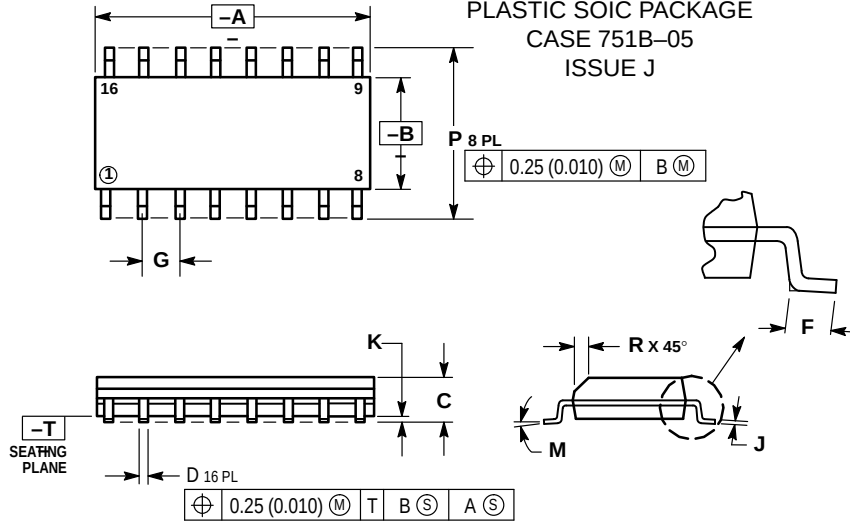


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.070	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

D SUFFIX
PLASTIC SOIC PACKAGE
CASE 751B-05
ISSUE J

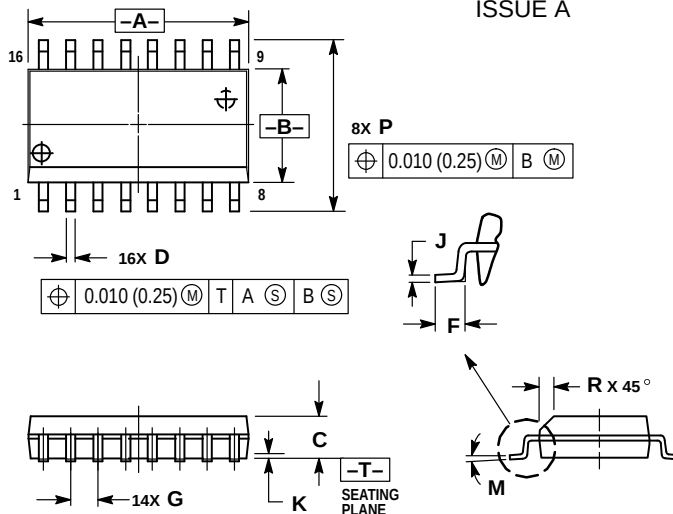


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.80	10.00	0.386	0.393
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

DW SUFFIX
PLASTIC SOIC PACKAGE
CASE 751G-02
ISSUE A

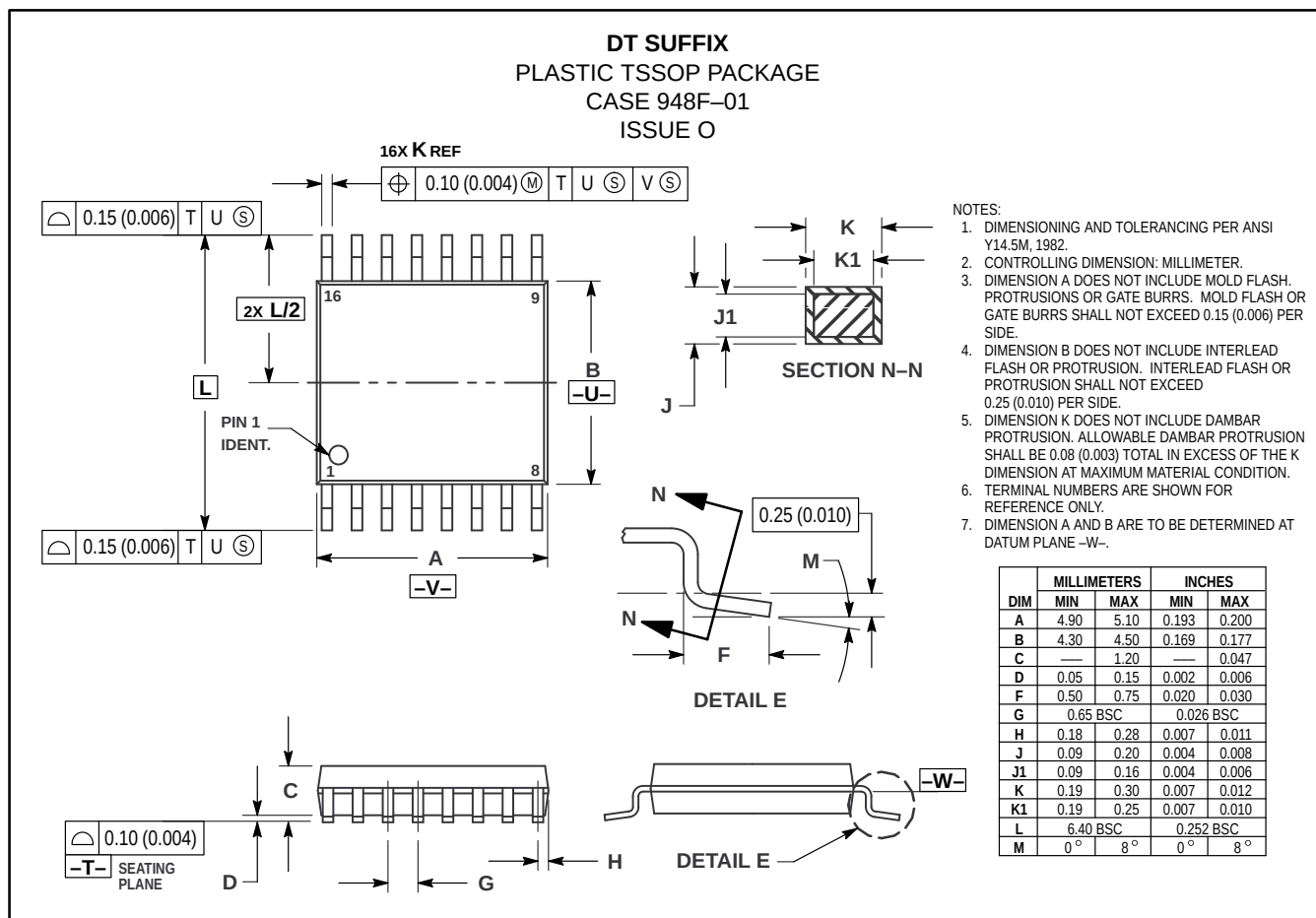


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DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	10.15	10.45	0.400	0.411
B	7.40	7.60	0.292	0.299
C	2.35	2.65	0.093	0.104
D	0.35	0.49	0.014	0.019
F	0.50	0.90	0.020	0.035
G	1.27 BSC		0.050 BSC	
J	0.25	0.32	0.010	0.012
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	10.05	10.55	0.395	0.415
R	0.25	0.75	0.010	0.029

OUTLINE DIMENSIONS



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